

**N-Ch MOSFET** 

#### **General Description**

The WSR25N20 is the highest performance trench N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSR25N20 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

#### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline

Absolute Maximum Ratings

• Green Device Available

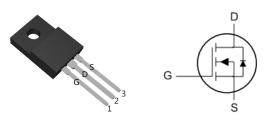
### **Product Summery**

BV <sub>DSS</sub>	R <sub>DSON</sub>	I <sub>D</sub>
200V	60mΩ	25A

#### Applications

- High Frequency Point-of-Load Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch

#### **TO-220F Pin Configuration**



#### Symbol **Parameter** Rating Units 200 v **Drain-Source Voltage** $V_{DS}$ V Gate-Source Voltage $\pm 20$ $V_{\text{GS}}$ Continuous Drain Current, V<sub>GS</sub> @ 10V<sup>1</sup> 25 А I<sub>D</sub>@T<sub>C</sub>=25℃ Continuous Drain Current, V<sub>GS</sub> @ 10V<sup>1</sup> 17 I<sub>D</sub>@T<sub>C</sub>=100℃ А Pulsed Drain Current<sup>2</sup> 100 А $I_{DM}$ Single Pulse Avalanche Energy<sup>3</sup> EAS 250 mJ $P_{D}$ 45 W Total Power Dissipation<sup>3</sup> °C T<sub>STG</sub> Storage Temperature Range -55 to 175 °C ΤJ **Operating Junction Temperature Range** -55 to 175

#### Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R <sub>eJA</sub>	Thermal Resistance Junction-ambient <sup>1</sup>		3.3	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		0.2	°C/W



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# Electrical Characteristics (T<sub>J</sub>=25<sup>-1</sup>C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	200			V	
$\triangle BV_{DSS} / \triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$ , I_D=1mA		0.098		V/℃	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =15A		60	75	mΩ	
V <sub>GS(th)</sub>	Gate Threshold Voltage		1.0	1.5	2.5	V	
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	VGS-VDS, ID -2300A		-4.57		mV/℃	
	Drain Source Leekage Current	$V_{DS}$ =160V , $V_{GS}$ =0V , TJ=25 $^\circ$ C			1		
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =160V , $V_{GS}$ =0V , $T_J$ =55 $^\circ$ C			5	- uA	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm25V$ , $V_{DS}$ =0V			±100	nA	
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =15A		32		S	
Qg	Total Gate Charge (10V)			60			
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =100V , V <sub>GS</sub> =10V , I <sub>D</sub> =15A		19		nC	
Q <sub>gd</sub>	Gate-Drain Charge			17		]	
T <sub>d(on)</sub>	Turn-On Delay Time			10			
Tr	Rise Time	V <sub>DD</sub> =30V , V <sub>GS</sub> =10V ,		18			
T <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> =6Ω, I <sub>D</sub> =15A, RL=30Ω		22		ns	
T <sub>f</sub>	Fall Time			5			
C <sub>iss</sub>	Input Capacitance			4200			
Coss	Output Capacitance	V <sub>DS</sub> =30V , V <sub>GS</sub> =0V , f=1MHz		163		pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			75			

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,6</sup>				24	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>	$V_G = V_D = 0V$ , Force Current			48	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =12A , T <sub>J</sub> =25℃			1.2	V
t <sub>rr</sub>	Reverse Recovery Time			90		nS
Qrr	Reverse Recovery Charge	IF=12A , dI/dt=100A/µs , Tյ=25℃		300		nC

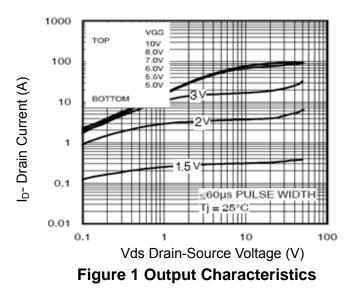
#### Notes:

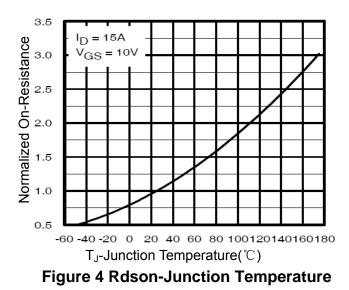
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ\!\mathrm{C},V_{DD}$ =50V,V\_G=10V,L=0.5mH,Rg=25 $\Omega$

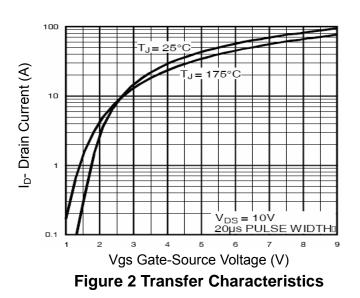


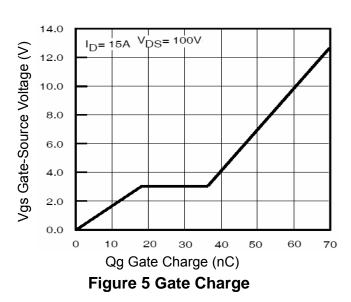
**N-Ch MOSFET** 

# **Typical Characteristics**





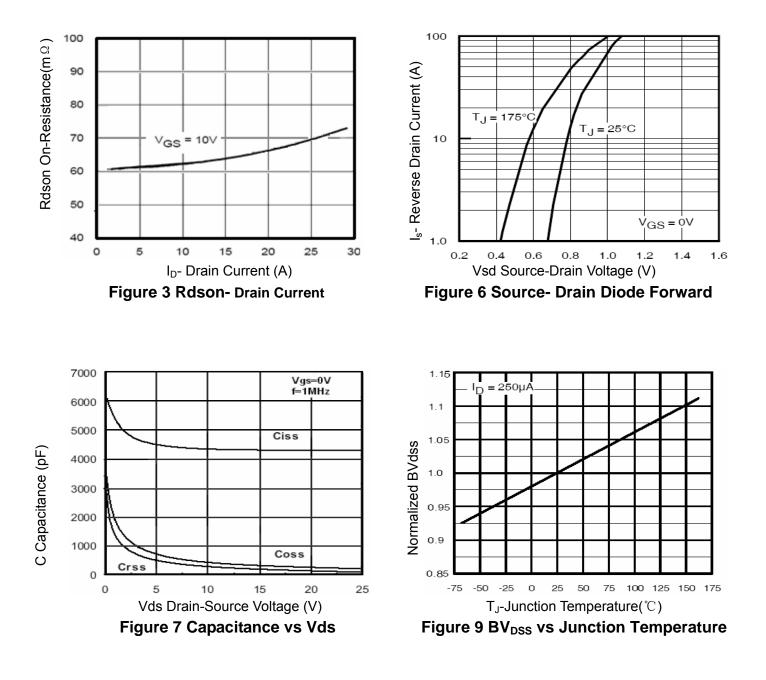






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# **Typical Characteristics**





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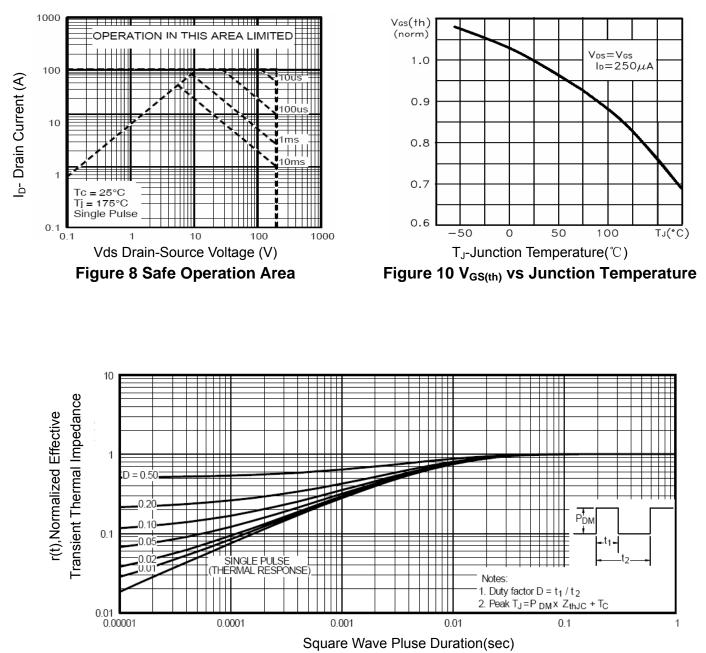
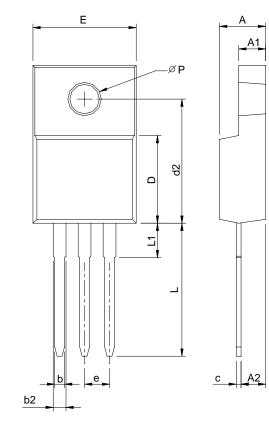


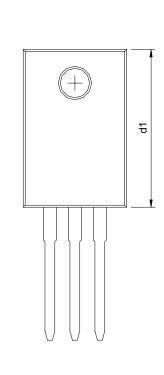
Figure 11 Normalized Maximum Transient Thermal Impedance



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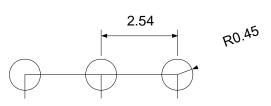
# **TO-220F** Package Information





Ş	TO-220F					
SY MBO_	MILLIMETERS		INC	HES		
6	MIN.	MAX.	MIN.	MAX.		
А	4.20	4.80	0.165	0.189		
A1	2.34	3.20	0.092	0.126		
A2	2.10	2.90	0.083	0.114		
b	0.50	0.90	0.020	0.035		
b2	0.91	1.90	0.035	0.075		
С	0.30	0.80	0.012	0.031		
D	8.10	9.40	0.319	0.370		
d1	14.50	16.50	0.571	0.650		
d2	12.10	12.90	0.476	0.508		
Е	9.70	10.70	0.382	0.421		
е	2.54 BSC		0.10	0 BSC		
L	13.00	14.50	0.512	0.570		
L1	1.60	4.00	0.063	0.157		
Ρ	3.00	3.60	0.118	0.142		

# **RECOMMENDED LAND PATTERN**



UNIT: mm



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